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DOCKET NO. 00-253/1D FETF: 81605

In the Specification:

Replace the paragraph beginning on page 1, line 6 as follows:

-- CROSS REFERENCE TO RELATED APPLICATIONS

This is a Divisional Application of pending U.S. Patent Application No. 09/680,759, for BALANCED COEFFICIENT OF THERMAL EXPANSION FOR FLIP CHIP BALL GRID ARRAY, filed October 6, 2000, by Nagarajan, et al., now U.S. Patent No. 6,639,321.